



**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Patent application of

Docket No: Q76863

Toshinobu OGATSU

Appln. No.: 10/694,841

Group Art Unit: 2851

Confirmation No.: 2499

Examiner: Rodney Evan FULLER

Filed: October 29, 2003

For: WAFER SUPPORT DEVICE AND A WAFER SUPPORT METHOD

**EXCESS CLAIM FEE PAYMENT LETTER**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

An Amendment Under 37 C.F.R. § 1.114(c) is attached hereto for concurrent filing in the above-identified application. The resulting excess claim fee has been calculated as shown below:

	After Amendment		Highest No. Previously Paid For					
All Claims	<u>27</u>	-	<u>20</u>	=	<u>7</u>	X	<u>\$50.00</u>	= <u>\$350.00</u>
Independent	<u>5</u>	-	<u>3</u>	=	<u>2</u>	X	<u>\$200.00</u>	= <u>\$400.00</u>
<b>TOTAL</b>								<b>= <u>\$750.00</u></b>

A check for the statutory fee of \$750.00 is attached. The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account. A

Excess Claim Fee Payment Letter  
U.S. Application No. 10/694,841

duplicate copy of this letter is enclosed.

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WASHINGTON OFFICE

**23373**

CUSTOMER NUMBER

Respectfully submitted,



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Date: November 7, 2005